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# MF1S50yyX

MIFARE Classic 1K - Mainstream contactless smart card IC for fast and easy solution development

Rev. 3.0 — 2 May 2011 196330 Product data sheet COMPANY PUBLIC

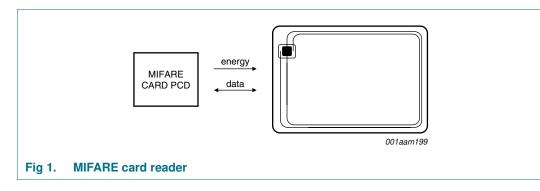
## 1. General description

NXP Semiconductors has developed the MIFARE Classic MF1S50yyX to be used in a contactless smart card according to ISO/IEC 14443 Type A.

The MIFARE Classic 1K MF1S50yyX IC is used in applications like public transport ticketing and can also be used for various other applications.

## **1.1 Anticollision**

An intelligent anticollision function allows to operate more than one card in the field simultaneously. The anticollision algorithm selects each card individually and ensures that the execution of a transaction with a selected card is performed correctly without interference from another card in the field.



## 1.2 Simple integration and user convenience

The MF1S50yyX is designed for simple integration and user convenience which allows complete ticketing transactions to be handled in less than 100 ms.

## 1.3 Security

- Manufacturer programmed 7-byte UID or 4-byte NUID identifier for each device
- Random ID support
- Mutual three pass authentication (ISO/IEC DIS 9798-2)
- · Individual set of two keys per sector to support multi-application with key hierarchy



## 1.4 Delivery options

- 7-byte UID, 4-byte NUID
- · bumped die on wafer
- MOA4 and MOA8 contactless module

#### 2. Features and benefits

- Contactless transmission of data and supply energy
- Operating frequency of 13.56 MHz
- Data integrity of 16-bit CRC, parity, bit coding, bit counting
- Typical ticketing transaction time of < 100 ms (including backup management)

## 2.1 EEPROM

- 1 kB, organized in 16 sectors of 4 blocks User definable access conditions for (one block consists of 16 byte)
- Data retention time of 10 years

- Operating distance up to 100 mm depending on antenna geometry and reader configuration
- Data transfer of 106 kbit/s
- Anticollision

- each memory block
- Write endurance 100000 cycles

#### **Applications** 3.

- Public transportation
- Electronic toll collection
- School and campus cards
- Internet cafés

- Access management
- Car parking
- Employee cards
- Loyalty

#### Quick reference data 4.

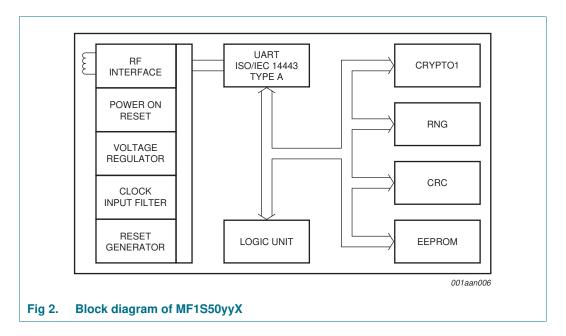
Table 1.	Quick reference data	L					
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Ci	input capacitance		<u>[1]</u>	14.9	16.9	19.0	pF
f <sub>i</sub>	input frequency			-	13.56	-	MHz
EEPROM	characteristics						
t <sub>ret</sub>	retention time	$T_{amb} = 22 \ ^{\circ}C$		10	-	-	year
N <sub>endu(W)</sub>	write endurance	$T_{amb} = 22 \ ^{\circ}C$		100000	200000	-	cycle

[1] LCR meter,  $T_{amb} = 22 \text{ °C}$ ,  $f_i = 13.56 \text{ MHz}$ , 2 V RMS.

# 5. Ordering information

Type number	Package		
	Name	Description	Version
MF1S5001XDUD	FFC Bump	8 inch wafer, 120 $\mu m$ thickness, on film frame carrier, electronic fail die marking according to SECS-II format), Au bumps, 7-byte UID	-
MF1S5001XDUF	FFC Bump	8 inch wafer, 75 $\mu m$ thickness, on film frame carrier, electronic fail die marking according to SECS-II format), Au bumps, 7-byte UID	-
MF1S5000XDA4	MOA4	plastic leadless module carrier package; 35 mm wide tape, 7-byte UID	SOT500-2
MF1S5000XDA8	MOA8	plastic leadless module carrier package; 35 mm wide tape, 7-byte UID	SOT500-4
MF1S5031XDUD	FFC Bump	8 inch wafer, 120 $\mu m$ thickness, on film frame carrier, electronic fail die marking according to SECS-II format), Au bumps, 4-byte non-unique ID	-
MF1S5031XDUF	FFC Bump	8 inch wafer, 75 $\mu m$ thickness, on film frame carrier, electronic fail die marking according to SECS-II format), Au bumps, 4-byte non-unique ID	-
MF1S5030XDA4	MOA4	plastic leadless module carrier package; 35 mm wide tape, 4-byte non-unique ID	SOT500-2
MF1S5030XDA8	MOA8	plastic leadless module carrier package; 35 mm wide tape, 4-byte non-unique ID	SOT500-4

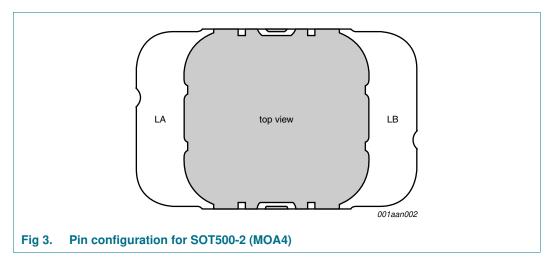
# 6. Block diagram



## 7. Pinning information

## 7.1 Pinning

The pinning for the MF1S50yyXDAx is shown as an example in <u>Figure 3</u> for the MOA4 contactless module. For the contactless module MOA8, the pinning is analogous and not explicitly shown.



#### Table 3.Pin allocation table

Pin	Symbol	
LA	LA	Antenna coil connection LA
LB	LB	Antenna coil connection LB

## 8. Functional description

## 8.1 Block description

The MF1S50yyX chip consists of a 1 kB EEPROM, RF interface and Digital Control Unit. Energy and data are transferred via an antenna consisting of a coil with a small number of turns which is directly connected to the MF1S50yyX. No further external components are necessary. Refer to the document Ref. 1 for details on antenna design.

- RF interface:
  - Modulator/demodulator
  - Rectifier
  - Clock regenerator
  - Power-On Reset (POR)
  - Voltage regulator
- · Anticollision: Multiple cards in the field may be selected and managed in sequence
- Authentication: Preceding any memory operation the authentication procedure ensures that access to a block is only possible via the two keys specified for each block
- Control and Arithmetic Logic Unit: Values are stored in a special redundant format and can be incremented and decremented
- EEPROM interface
- Crypto unit: The CRYPTO1 stream cipher of the MF1S50yyX is used for authentication and encryption of data exchange.
- EEPROM: 1 kB is organized in 16 sectors of 4 blocks. One block contains 16 bytes. The last block of each sector is called "trailer", which contains two secret keys and programmable access conditions for each block in this sector.

## 8.2 Communication principle

The commands are initiated by the reader and controlled by the Digital Control Unit of the MF1S50yyX. The command response is depending on the state of the IC and for memory operations also on the access conditions valid for the corresponding sector.

## 8.2.1 Request standard / all

After Power-On Reset (POR) the card answers to a request REQA or wakeup WUPA command with the answer to request code (see <u>Section 9.4</u>, ATQA according to ISO/IEC 14443A).

## 8.2.2 Anticollision loop

In the anticollision loop the identifier of a card is read. If there are several cards in the operating field of the reader, they can be distinguished by their identifier and one can be selected (select card) for further transactions. The unselected cards return to the idle state and wait for a new request command. If the 7-byte UID is used for anticollision and selection, two cascade levels need to be processes as defined in ISO/IEC 14443-3.

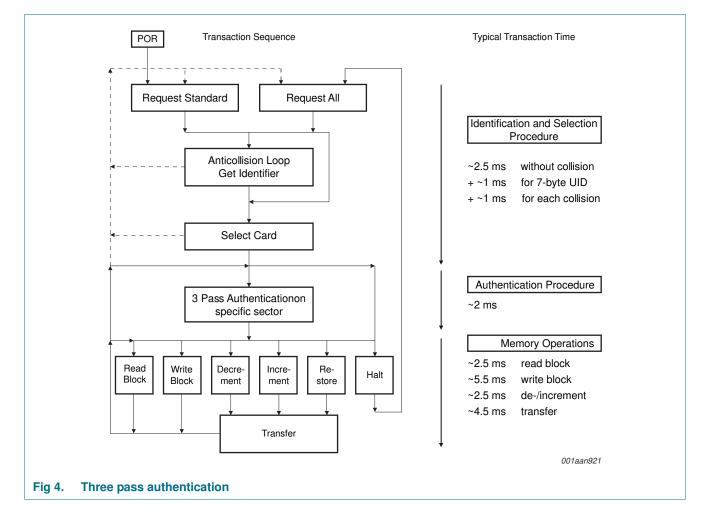
**Remark:** For the 4-byte non-unique ID product versions, the identifier retrieved from the card is not defined to be unique. For further information regarding handling of non-unique identifiers see <u>Ref. 6</u>.

#### 8.2.3 Select card

With the select card command the reader selects one individual card for authentication and memory related operations. The card returns the Select AcKnowledge (SAK) code which determines the type of the selected card, see <u>Section 9.4</u>. For further details refer to the document <u>Ref. 2</u>.

### 8.2.4 Three pass authentication

After selection of a card the reader specifies the memory location of the following memory access and uses the corresponding key for the three pass authentication procedure. After a successful authentication all memory operations are encrypted.



### 8.2.5 Memory operations

After authentication any of the following operations may be performed:

- Read block
- Write block
- Decrement: Decrements the contents of a block and stores the result in an internal data-register
- Increment: Increments the contents of a block and stores the result in an internal data-register
- · Restore: Moves the contents of a block into an internal data-register
- Transfer: Writes the contents of the temporary internal data-register to a value block

## 8.3 Data integrity

Following mechanisms are implemented in the contactless communication link between reader and card to ensure very reliable data transmission:

- 16 bits CRC per block
- Parity bits for each byte
- Bit count checking
- Bit coding to distinguish between "1", "0" and "no information"
- Channel monitoring (protocol sequence and bit stream analysis)

## 8.4 Three pass authentication sequence

- 1. The reader specifies the sector to be accessed and chooses key A or B.
- 2. The card reads the secret key and the access conditions from the sector trailer. Then the card sends a number as the challenge to the reader (pass one).
- 3. The reader calculates the response using the secret key and additional input. The response, together with a random challenge from the reader, is then transmitted to the card (pass two).
- 4. The card verifies the response of the reader by comparing it with its own challenge and then it calculates the response to the challenge and transmits it (pass three).
- 5. The reader verifies the response of the card by comparing it to its own challenge.

After transmission of the first random challenge the communication between card and reader is encrypted.

### 8.5 RF interface

The RF-interface is according to the standard for contactless smart cards ISO/IEC 14443A.

For operation, the carrier field from the reader always needs to be present (with short pauses when transmitting), as it is used for the power supply of the card.

For both directions of data communication there is only one start bit at the beginning of each frame. Each byte is transmitted with a parity bit (odd parity) at the end. The LSB of the byte with the lowest address of the selected block is transmitted first. The maximum frame length is 163 bits (16 data bytes + 2 CRC bytes =  $16 \times 9 + 2 \times 9 + 1$  start bit).

## 8.6 Memory organization

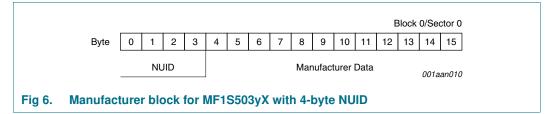
The 1024  $\times$  8 bit EEPROM memory is organized in 16 sectors of 4 blocks. One block contains 16 bytes.

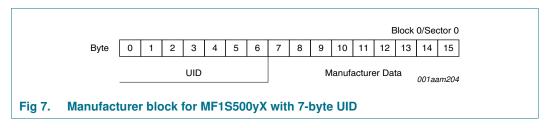
Sector	Block	0	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	Description
15	3			Ke	y A			A	cces	s Bi	ts			Key	/ B			Sector Trailer 15
	2																	Data
	1																	Data
	0																	Data
14	3			Ke	y A			A	cces	s Bi	ts			Key	/ B			Sector Trailer 14
	2																	Data
	1																	Data
	0																	Data
:	:																	
:	:																	
:	:																	
1	3			Ke	y A			A	cces	s Bi	ts			Key	/ B			Sector Trailer 1
	2																	Data
	1																	Data
	0																	Data
0	3			Ke	y A			A	cces	s Bi	ts			Key	/ B			Sector Trailer 0
	2																	Data
	1																	Data
	0						N	/lanu	lfact	urer	Dat	a						Manufacturer Block

Fig 5. Memory organization

### 8.6.1 Manufacturer block

This is the first data block (block 0) of the first sector (sector 0). It contains the IC manufacturer data. This block is programmed and write protected in the production test. The manufacturer block is shown in <u>Figure 6</u> and <u>Figure 7</u> for the 4-byte NUID and 7-byte UID version respectively.





### 8.6.2 Data blocks

All sectors contain 3 blocks of 16 bytes for storing data (Sector 0 contains only two data blocks and the read-only manufacturer block).

The data blocks can be configured by the access bits as

- read/write blocks
- value blocks

Value blocks can be used for e.g. electronic purse applications, where additional commands like increment and decrement for direct control of the stored value are provided

A successful authentication has to be performed to allow any memory operation.

**Remark:** The default content of the data blocks at delivery is not defined.

#### 8.6.2.1 Value blocks

Value blocks allow performing electronic purse functions (valid commands are: read, write, increment, decrement, restore, transfer). Value blocks have a fixed data format which permits error detection and correction and a backup management.

A value block can only be generated through a write operation in value block format:

• Value: Signifies a signed 4-byte value. The lowest significant byte of a value is stored in the lowest address byte. Negative values are stored in standard 2's complement format. For reasons of data integrity and security, a value is stored three times, twice non-inverted and once inverted.

• Adr: Signifies a 1-byte address, which can be used to save the storage address of a block, when implementing a powerful backup management. The address byte is stored four times, twice inverted and non-inverted. During increment, decrement, restore and transfer operations the address remains unchanged. It can only be altered via a write command.

Byte Number	0	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15
Description		va	lue			va	ue			va	ue		adr	adr	adr	adr

#### Fig 8. Value blocks

An example of a valid value block format for the decimal value 1234567d and the block address 17d is shown in <u>Table 4</u>. First, the decimal value has to be converted to the hexadecimal representation of 0012D687h. The LSByte of the hexadecimal value is stored in Byte 0, the MSByte in Byte 3. The bit inverted hexadecimal representation of the value is FFED2978h where the LSByte is stored in Byte 4 and the MSByte in Byte 7.

The hexadecimal value of the address in the example is 11h, the bit inverted hexadecimal value is EEh.

#### Table 4.Value block format example

Byte Number	0	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15
Description		va	ue			va	lue			val	ue		adr	adr	adr	adr
Values [hex]	84	D6	12	00	78	29	ED	FF	84	D6	12	00	11	EE	11	EE

## 8.6.3 Sector trailer

The sector trailer is the last block (block 3) in one sector. Each sector has a sector trailer containing the

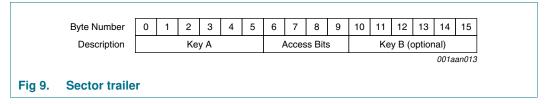
- secret keys A (mandatory) and B (optional), which return logical "0"s when read and
- the access conditions for the blocks of that sector, which are stored in bytes 6...9. The access bits also specify the type (data or value) of the data blocks.

If key B is not needed, the last 6 bytes of the sector trailer can be used as data bytes. The access bits for the sector trailer have to be configured accordingly, see <u>Section 8.7.2</u>.

Byte 9 of the sector trailer is available for user data. For this byte the same access rights as for byte 6, 7 and 8 apply.

When the sector trailer is read, the key bytes are blanked out by returning logical zeros. If key B is configured to be readable, the data stored in bytes 10 to 15 is returned, see <u>Section 8.7.2</u>.

All keys are set to FFFF FFFF FFFFh at chip delivery.



### 8.7 Memory access

Before any memory operation can be done, the card has to be selected and authenticated as described in <u>Section 8.2</u>. The possible memory operations for an addressed block depend on the key used during authentication and the access conditions stored in the associated sector trailer.

Table 5.	Memory operations	
Operation	Description	Valid for Block Type
Read	reads one memory block	read/write, value and sector trailer
Write	writes one memory block	read/write, value and sector trailer
Increment	increments the contents of a block and stores the result in the internal data register	value
Decremen	decrements the contents of a block and stores the result in the internal data register	value
Transfer	writes the contents of the internal data register to a block	value
Restore	reads the contents of a block into the internal data register	value

#### 8.7.1 Access conditions

The access conditions for every data block and sector trailer are defined by 3 bits, which are stored non-inverted and inverted in the sector trailer of the specified sector.

The access bits control the rights of memory access using the secret keys A and B. The access conditions may be altered, provided one knows the relevant key and the current access condition allows this operation.

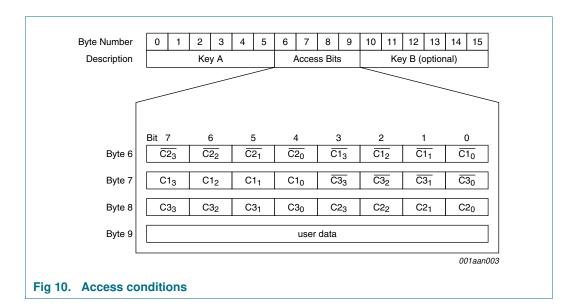
**Remark:** With each memory access the internal logic verifies the format of the access conditions. If it detects a format violation the whole sector is irreversibly blocked.

**Remark:** In the following description the access bits are mentioned in the non-inverted mode only.

The internal logic of the MF1S50yyX ensures that the commands are executed only after a successful authentication.

Table 6. Acces	s conditions			
Access Bits	Valid Commands		Block	Description
C1 <sub>3</sub> , C2 <sub>3</sub> , C3 <sub>3</sub>	read, write	$\rightarrow$	3	sector trailer
C1 <sub>2</sub> , C2 <sub>2</sub> , C3 <sub>2</sub>	read, write, increment, decrement, transfer, restore	$\rightarrow$	2	data block
C1 <sub>1</sub> , C2 <sub>1</sub> , C3 <sub>1</sub>	read, write, increment, decrement, transfer, restore	$\rightarrow$	1	data block
C1 <sub>0</sub> ,C2 <sub>0</sub> , C3 <sub>0</sub>	read, write, increment, decrement, transfer, restore	$\rightarrow$	0	data block

#### Table 6.Access conditions



### 8.7.2 Access conditions for the sector trailer

Depending on the access bits for the sector trailer (block 3) the read/write access to the keys and the access bits is specified as 'never', 'key A', 'key B' or key A|B' (key A or key B).

On chip delivery the access conditions for the sector trailers and key A are predefined as transport configuration. Since key B may be read in the transport configuration, new cards must be authenticated with key A. Since the access bits themselves can also be blocked, special care has to be taken during the personalization of cards.

Acc	ess b	oits	Access	condition	for				Remark
			KEYA		Access	bits	KEYB		
C1	C2	C3	read	write	read	write	read	write	
0	0	0	never	key A	key A	never	key A	key A	Key B may be read <sup>[1]</sup>
0	1	0	never	never	key A	never	key A	never	Key B may be read <sup>[1]</sup>
1	0	0	never	key B	key A B	never	never	key B	
1	1	0	never	never	key A B	never	never	never	
0	0	1	never	key A	key A	key A	key A	key A	Key B may be read, transport configuration <sup>[1]</sup>
0	1	1	never	key B	key A B	key B	never	key B	
1	0	1	never	never	key A B	key B	never	never	
1	1	1	never	never	key A B	never	never	never	

## Table 7. Access conditions for the sector trailer

[1] For this access condition key B is readable and may be used for data

### 8.7.3 Access conditions for data blocks

Depending on the access bits for data blocks (blocks 0...2) the read/write access is specified as 'never', 'key A', 'key B' or 'key A|B' (key A or key B). The setting of the relevant access bits defines the application and the corresponding applicable commands.

- Read/write block: the operations read and write are allowed.
- Value block: Allows the additional value operations increment, decrement, transfer and restore. With access condition '001' only read and decrement are possible which reflects a non-rechargeable card. For access condition '110' recharging is possible by using key B.
- Manufacturer block: the read-only condition is not affected by the access bits setting!
- Key management: in transport configuration key A must be used for authentication

Acc	ess bi	its	Access cond	lition for			Application
C1	C2	C3	read	write	increment	decrement, transfer, restore	
0	0	0	key A∣B	key A B	key A B	key A B	transport configuration <sup>[1]</sup>
0	1	0	key A B	never	never	never	read/write block <sup>[1]</sup>
1	0	0	key A B	key B	never	never	read/write block <sup>[1]</sup>
1	1	0	key A B	key B	key B	key A B	value block <sup>[1]</sup>
0	0	1	key A B	never	never	key A B	value block <sup>[1]</sup>
0	1	1	key B	key B	never	never	read/write block <sup>[1]</sup>
1	0	1	key B	never	never	never	read/write block <sup>[1]</sup>
1	1	1	never	never	never	never	read/write block

#### Table 8. Access conditions for data blocks

[1] If key B may be read in the corresponding Sector Trailer it cannot serve for authentication (see grey marked lines in <u>Table 7</u>). As a consequences, if the reader authenticates any block of a sector which uses such access conditions for the Sector Trailer and using key B, the card will refuse any subsequent memory access after authentication.

Product data sheet

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## 9. Command overview

The MIFARE Classic card activation follows the ISO/IEC 14443 Type A. After the MIFARE Classic card has been selected, it can either be deactivated using the ISO/IEC 14443 Halt command, or the MIFARE Classic commands can be performed. For more details about the card activation refer to <u>Ref. 4</u>.

## 9.1 MIFARE Classic command overview

All MIFARE Classic commands use the MIFARE CRYPTO1 and require an authentication.

All available commands for the MIFARE Classic are shown in Table 9.

Command	ISO/IEC 14443	Command code (hexadecimal)
Request	REQA	26h (7 bit)
Wake-up	WUPA	52h (7 bit)
Anticollision CL1	Anticollision CL1	93h 20h
Select CL1	Select CL1	93h 70h
Anticollision CL2	Anticollision CL2	95h 20h
Select CL2	Select CL2	95h 70h
Halt	Halt	50h 00h
Authentication with Key A	-	60h
Authentication with Key B	-	61h
Personalize UID Usage	-	40h
MIFARE Read	-	30h
MIFARE Write	-	A0h
MIFARE Decrement	-	C0h
MIFARE Increment	-	C1h
MIFARE Restore	-	C2h
MIFARE Transfer	-	B0h

#### Table 9.Command overview

All commands use the coding and framing as described in <u>Ref. 3</u> and <u>Ref. 4</u> if not otherwise specified.

## 9.2 Timings

The timing shown in this document are not to scale and values are rounded to 1  $\mu$ s.

All given times refer to the data frames including start of communication and end of communication, but do not include the encoding (like the Miller pulses).

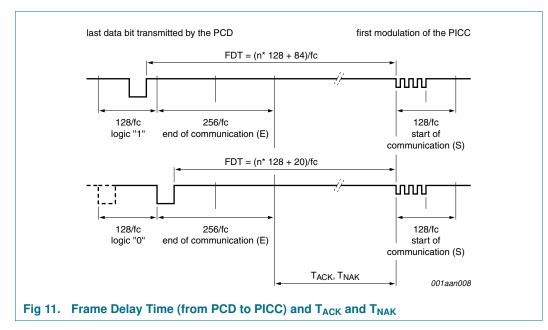
Consequently a data frame sent by the PCD contains the start of communication (1 "start bit") and the end of communication (one logic 0 + 1 bit length of unmodulated carrier).

A data frame sent by the PICC contains the start of communication (1 "start bit") and the end of communication (1 bit length of no subcarrier).

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All timing can be measured according to ISO/IEC 14443-3 frame specification as shown for the Frame Delay Time in Figure 11. For more details refer to Ref. 3 and Ref. 4.



The frame delay time from PICC to PCD must be at least 87  $\mu s.$ 

**Remark:** Due to the coding of commands, the measured timings usually excludes (a part of) the end of communication. This needs to be considered, when comparing the specified with the measured times.

## 9.3 MIFARE Classic ACK and NAK

The MIFARE Classic uses a 4 bit ACK / NAK as shown in Table 10.

Table 10. MIFARE	ACK and NAK
Code (4-bit)	ACK/NAK
Ah	Acknowledge (ACK)
0h to 9h, Bh to Fh	NAK

## 9.4 ATQA and SAK responses

For details on the type identification procedure please refer to  $\underline{\text{Ref. 2}}$ .

The MF1S50yyX answers to a REQA or WUPA command with the ATQA value shown in Table 11 and to a Select CL1 command (CL2 for the 7-byte UID variant) with the SAK value shown in Table 12.

#### Table 11. ATQA response of the MF1S50yyX

								Bi	it Nu	ımb	er						
Sales Type	Hex Value	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1
MF1S500yX	00 44h	0	0	0	0	0	0	0	0	0	1	0	0	0	1	0	0
MF1S503yX	00 04h	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0

#### Table 12. SAK response of the MF1S50yyX

			Bit Number						
Sales Type	Hex Value	8	7	6	5	4	3	2	1
MF1S50yyX	08h	0	0	0	0	1	0	0	0

**Remark:** The ATQA coding in bits 7 and 8 indicate the UID size according to ISO/IEC 14443 independent from the settings of the UID usage.

**Remark:** The bit numbering in the ISO/IEC 14443 starts with LSBit = bit 1, but not LSBit = bit 0. So one byte counts bit 1 to 8 instead of bit 0 to 7.

## **10. UID Options and Handling**

The MF1S50yyX product family offers two delivery options for the UID which is stored in block 0 of sector 0.

- 7-byte UID
- 4-byte NUID (Non-Unique ID)

This section describes the MIFARE Classic MF1S50yyX operation when using one of the 2 UID options with respect to card selection, authentication and personalization. See also Ref. 6 for details on how to handle UIDs and NUIDs with MIFARE Classic products.

## 10.1 7-byte UID Operation

All MF1S50**0**yXDyy products are featuring a 7-byte UID. This 7-byte UID is stored in block 0 of sector 0 as shown in <u>Figure 7</u>. The behaviour during anti-collision, selection and authentication can be configured during personalization for this UID variant.

## 10.1.1 Personalization Options

The 7-byte UID variants of the MF1S50yyX can be operated with four different functionalities, denoted as UIDFn (UID Functionality n).

- 1. UIDF0: anti-collision and selection with the double size UID according to ISO/IEC 14443-3
- 2. UIDF1: anti-collision and selection with the double size UID according to ISO/IEC 14443-3 and optional usage of a selection process shortcut
- 3. UIDF2: anti-collision and selection with a single size random ID according to ISO/IEC 14443-3
- 4. UIDF3: anti-collision and selection with a single size NUID according to ISO/IEC 14443-3 where the NUID is calculated out of the 7-byte UID

The anti-collision and selection procedure and the implications on the authentication process are detailed in <u>Section 10.1.2</u> and <u>Section 10.1.3</u>.

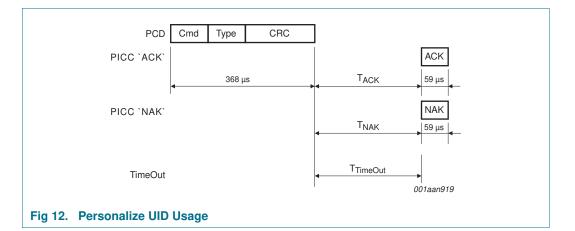
The default configuration at delivery is option 1 which enables the ISO/IEC 14443-3 compliant anti-collision and selection. This configuration can be changed using the 'Personalize UID Usage' command. The execution of this command requires an authentication to sector 0. Once this command has been issued and accepted by the PICC, the configuration is automatically locked. A subsequently issued 'Personalize UID Usage' command is not executed and a NAK is replied by the PICC.

**Remark:** As the configuration is changeable at delivery, it is strongly recommended to send this command at personalization of the card to prevent unwanted changes in the field. This should also be done if the default configuration is used.

**Remark:** The configuration only becomes effective only after PICC unselect or PICC field reset.

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### MIFARE Classic 1K - Mainstream contactless smart card IC



#### Table 13. Personalize UID Usage command

Name	Code	Description	Length
Cmd	40h	Set anti-collision, selection and authentication behaviour	1 byte
Туре	-	Encoded type of UID usage: UIDF0: 00h UIDF1: 40h UIDF2: 20h UIDF3: 60h	1 byte
CRC	-	CRC according to Ref. 4	2 bytes
ACK, NAK	see Table 10	see Section 9.3	4-bit

#### Table 14. Personalize UID Usage timing

These times exclude the end of communication of the PCD.

	T <sub>ACK</sub> min	T <sub>ACK</sub> max	T <sub>NAK min</sub>	T <sub>NAK max</sub>	T <sub>TimeOut</sub>
Personalize UID Usage	71 μs	T <sub>TimeOut</sub>	71 μs	T <sub>TimeOut</sub>	10 ms

## 10.1.2 Anti-collision and Selection

Depending on the chosen personalization option there are certain possibilities to perform anti-collision and selection. To bring the MIFARE Classic into the ACTIVE state according to ISO/IEC 14443-3, the following sequences are available.

- Sequence 1: ISO/IEC 14443-3 compliant anti-collision and selection using the cascade level 1 followed by the cascade level 2 SEL command
- Sequence 2: using cascade level 1 anti-collision and selection procedure followed by a Read command from block 0
- Sequence 3: ISO/IEC 14443-3 compliant anti-collision and selection using the cascade level 1 SEL command

**Remark:** The Read from Block 0 in Sequence 2 does not require a prior authentication to Sector 0 and is transmitted in plain data. For all other sequences, the readout from Block 0 in Sector 0 is encrypted and requires an authentication to that sector.

Remark: The settings done with Personalize UID Usage do not change the ATQA coding.

Table 15.	Table 15.         Available activation sequences for 7-byte UID options						
<b>UID Func</b>	tionality	Available Activation Sequences					
UIDF0		Sequence 1					
UIDF1		Sequence 1, Sequence 2					
UIDF2		Sequence 3					
UIDF3		Sequence 3					

#### 10.1.3 Authentication

During the authentication process, 4-byte of the UID are passed on to the MIFARE Classic Authenticate command of the contactless reader IC. Depending on the activation sequence, those 4-byte are chosen differently.

Table 16. Input parameter to MIFARE Classic Authenticat	Table 16.	<b>MIFARE Classic Authenticate</b>
---	-----------	------------------------------------

UID Functionality	Input to MIFARE Classic Authenticate Command
Sequence 1	CL2 bytes (UID3UID6)
Sequence 2	CL1 bytes (CT, UID0UID2)
Sequence 3	4-byte NUID/RID (UID0UID3)

## 10.2 4-byte UID Operation

All MF1S50**3**yXDyy products are featuring a 4-byte NUID. This 4-byte NUID is stored in block 0 of sector 0 as shown in Figure 6.

#### 10.2.1 Anti-collision and Selection

The anti-collision and selection process for the product variants featuring 4-byte NUIDs is done according to ISO/IEC 14443-3 Type A using cascade level 1 only.

#### 10.2.2 Authentication

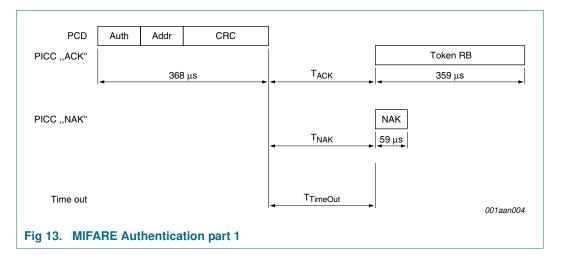
The input parameter to the MIFARE Classic Authenticate command is the full 4-byte UID retrieved during the anti-collision procedure. This is the same as for the activation Sequence 3 in the 7-byte UID variant.

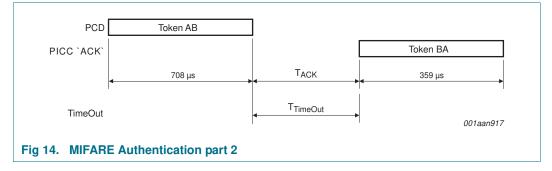
## **11. MIFARE Classic commands**

## 11.1 MIFARE Authentication

The MIFARE authentication is a 3-pass mutual authentication which needs two pairs of command-response. These two parts, MIFARE authentication part 1 and part 2 are shown in Figure 13, Figure 14 and Table 17.

Table 18 shows the required timing.





#### Table 17. MIFARE authentication command

Name	Code	Description	Length
Auth (with Key A)	60h	Authentication with Key A	1 byte
Auth (with Key B)	61h	Authentication with Key B	1 byte
Addr	-	MIFARE Block address (00h to FFh)	1 byte
CRC	-	CRC according to Ref. 4	2 bytes
Token RB	-	Challenge 1 (Random Number)	4 bytes
Token AB	-	Challenge 2 (encrypted data)	8 bytes
Token BA	-	Challenge 2 (encrypted data)	4 bytes
NAK	see <u>Table 10</u>	see Section 9.3	4-bit

#### Table 18. MIFARE authentication timing

These times exclude the end of communication of the PCD.

	T <sub>ACK</sub> min	T <sub>ACK</sub> max	T <sub>NAK min</sub>	T <sub>NAK max</sub>	T <sub>TimeOut</sub>
Authentication part 1	71 μs	T <sub>TimeOut</sub>	71 μs	T <sub>TimeOut</sub>	1 ms
Authentication part 2	71 μs	T <sub>TimeOut</sub>			1 ms

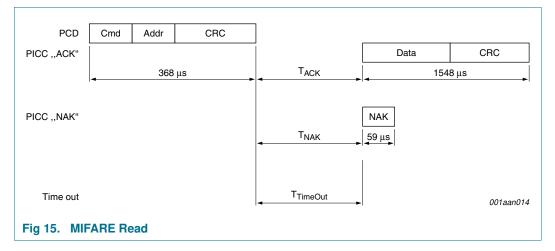
**Remark:** The minimum required time between MIFARE Authentication part 1 and part 2 is the minimum required FDT according to <u>Ref. 4</u>. There is no maximum time specified.

**Remark:** The MIFARE authentication and encryption requires an MIFARE reader IC (e.g. the CL RC632). For more details about the authentication command refer to the corresponding data sheet (e.g. <u>Ref. 5</u>). The 4-byte input parameter for the MIFARE Classic Authentication is detailed in <u>Section 10.1.3</u> and <u>Section 10.2.2</u>.

## 11.2 MIFARE Read

The MIFARE Read requires a block address, and returns the 16 bytes of one MIFARE Classic block. The command structure is shown in Figure 15 and Table 19.

Table 20 shows the required timing.



#### Table 19. MIFARE Read command

Name	Code	Description	Length
Cmd	30h	Read one block	1 byte
Addr	-	MIFARE Block address (00h to FFh)	1 byte
CRC	-	CRC according to Ref. 4	2 bytes
Data	-	Data content of the addressed block	16 bytes
NAK	see Table 10	see Section 9.3	4-bit

#### Table 20. MIFARE Read timing

These times exclude the end of communication of the PCD.

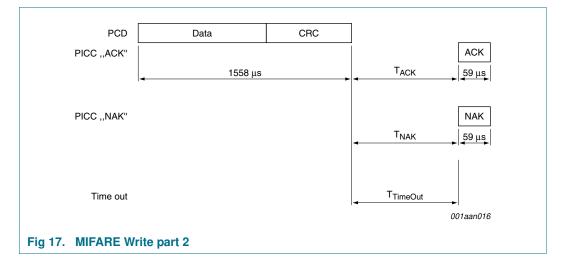
	T <sub>ACK</sub> min	T <sub>ACK</sub> max	T <sub>NAK min</sub>	T <sub>NAK max</sub>	T <sub>TimeOut</sub>
Read	71 μs	T <sub>TimeOut</sub>	71 μs	T <sub>TimeOut</sub>	5 ms

## 11.3 MIFARE Write

The MIFARE Write requires a block address, and writes 16 bytes of data into the addressed MIFARE Classic 1K block. It needs two pairs of command-response. These two parts, MIFARE Write part 1 and part 2 are shown in Figure 16 and Figure 17 and Table 21.

Table 22 shows the required timing.

				_	
PCD	Cmd	Addr	CRC		
PICC ,,ACK"					ACK
		368	βµs ►	T <sub>ACK</sub>	59 μs
PICC ,,NAK"					NAK
				≺ T <sub>NAK</sub>	59 μs
Time out				T <sub>TimeOut</sub>	
Time out				<ul> <li>ImeOut</li> </ul>	<b>&gt;</b>
					001aan015
Fig 16. MIFARE Write	part 1				



#### Table 21. MIFARE Write command

Name	Code	Description	Length
Cmd	A0h	Write one block	1 byte
Addr	-	MIFARE Block or Page address (00h to FFh)	1 byte
CRC	-	CRC according to Ref. 4	2 bytes
Data	-	Data	16 bytes
NAK	see Table 10	see Section 9.3	4-bit

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#### Table 22. MIFARE Write timing

These times exclude the end of communication of the PCD.

	T <sub>ACK</sub> min	T <sub>ACK</sub> max	T <sub>NAK min</sub>	T <sub>NAK max</sub>	T <sub>TimeOut</sub>
Write part 1	71 μs	T <sub>TimeOut</sub>	71 μ <b>s</b>	T <sub>TimeOut</sub>	5 ms
Write part 2	71 μs	T <sub>TimeOut</sub>	71 μs	T <sub>TimeOut</sub>	10 ms

**Remark:** The minimum required time between MIFARE Write part 1 and part 2 is the minimum required FDT according to <u>Ref. 4</u>. There is no maximum time specified.

## **11.4 MIFARE Increment, Decrement and Restore**

The MIFARE Increment requires a source block address and an operand. It adds the operand to the value of the addressed block, and stores the result in a volatile memory.

The MIFARE Decrement requires a source block address and an operand. It subtracts the operand from the value of the addressed block, and stores the result in a volatile memory.

The MIFARE Restore requires a source block address. It copies the value of the addressed block into a volatile memory.

All three commands are responding with a NAK to the first command part if the addressed block is not formatted to be a valid value block, see <u>Section 8.6.2.1</u>.

The two parts of each command are shown in Figure 18 and Figure 19 and Table 23.

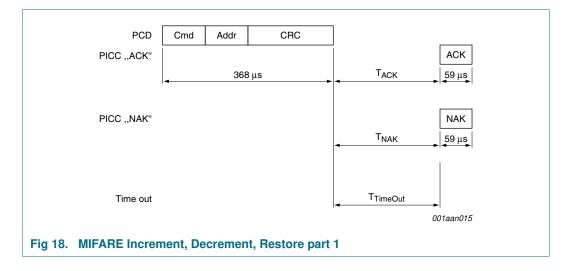


Table 24 shows the required timing.

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### MIFARE Classic 1K - Mainstream contactless smart card IC

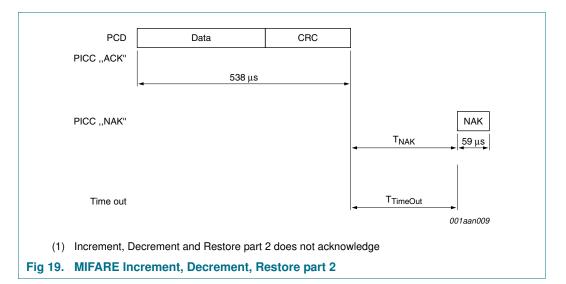


Table 23.	<b>MIFARE Increment.</b>	<b>Decrement and</b>	Restore command

Name	Code	Description	Length
Cmd	C1h	Increment	1 byte
Cmd	C0h	Decrement	1 byte
Cmd	C2h	Restore	1 byte
Addr	-	MIFARE source block address (00h to FFh)	1 byte
CRC	-	CRC according to Ref. 4	2 bytes
Data	-	Operand (4 byte signed integer)	4 bytes
NAK	see <u>Table 10</u>	see Section 9.3	4-bit

#### Table 24. MIFARE Increment, Decrement and Restore timing

These times exclude the end of communication of the PCD.

	T <sub>ACK</sub> min	T <sub>ACK</sub> max	T <sub>NAK min</sub>	T <sub>NAK max</sub>	T <sub>TimeOut</sub>
Increment, Decrement, and Restore part 1	71 μs	T <sub>TimeOut</sub>	71 μs	T <sub>TimeOut</sub>	5 ms
Increment, Decrement, and Restore part 2	71 μs	T <sub>TimeOut</sub>	71 μs	T <sub>TimeOut</sub>	5 ms

**Remark:** The minimum required time between MIFARE Increment, Decrement, and Restore part 1 and part 2 is the minimum required FDT according to <u>Ref. 4</u>. There is no maximum time specified.

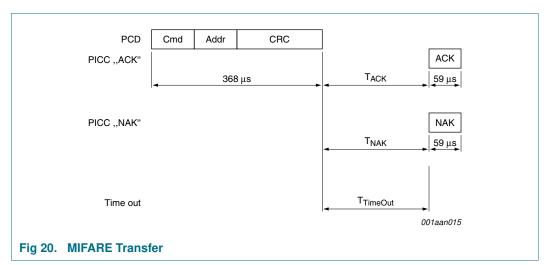
**Remark:** The MIFARE Increment, Decrement, and Restore commands require a MIFARE Transfer to store the value into a destination block.

**Remark:** The MIFARE Increment, Decrement, and Restore command part 2 does not provide an acknowledgement, so the regular time out has to be used instead.

## 11.5 MIFARE Transfer

The MIFARE Transfer requires a destination block address, and writes the value stored in the volatile memory into one MIFARE Classic block. The command structure is shown in Figure 20 and Table 25.

Table 26 shows the required timing.



#### Table 25. MIFARE Transfer command

Name	Code	Description	Length
Cmd	B0h	Write value into destination block	1 byte
Addr	-	MIFARE destination block address (00h to FFh)	1 byte
CRC	-	CRC according to Ref. 4	2 bytes
NAK	see Table 10	see Section 9.3	4-bit

#### Table 26. MIFARE Transfer timing

These times exclude the end of communication of the PCD.

	T <sub>ACK</sub> min	T <sub>ACK</sub> max	T <sub>NAK min</sub>	T <sub>NAK max</sub>	T <sub>TimeOut</sub>
Transfer	71 μs	T <sub>TimeOut</sub>	71 μs	T <sub>TimeOut</sub>	10 ms

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#### **MIFARE Classic 1K - Mainstream contactless smart card IC**

## 12. Limiting values

Stresses above one or more of the limiting values may cause permanent damage to the device. Exposure to limiting values for extended periods may affect device reliability.

#### Table 27. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Min	Max	Unit
I <sub>I</sub>	input current	-	30	mA
P <sub>tot</sub> /pack	total power dissipation per package	-	120	mW
T <sub>stg</sub>	storage temperature	-55	125	°C
T <sub>amb</sub>	ambient temperature	-25	70	°C
V <sub>ESD</sub>	electrostatic discharge voltage on LA/LB	2	-	kV
l <sub>lu</sub>	latch-up current	±100	-	mA

[1] ANSI/ESDA/JEDEC JS-001; Human body model: C = 100 pF, R = 1.5 k $\Omega$ 

# **13. Characteristics**

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Ci	input capacitance		[1]	14.9	16.9	19.0	pF
f <sub>i</sub>	input frequency			-	13.56	-	MHz
EEPROM	characteristics						
t <sub>ret</sub>	retention time	$T_{amb} = 22 \ ^{\circ}C$		10	-	-	year
N <sub>endu(W)</sub>	write endurance	T <sub>amb</sub> = 22 °C		100000	200000	-	cycle

[1] LCR meter,  $T_{amb} = 22 \ ^{\circ}C$ ,  $f_i = 13.56 \ MHz$ , 2 V RMS.

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#### MIFARE Classic 1K - Mainstream contactless smart card IC

## 14. Wafer specification

For more details on the wafer delivery forms see Ref. 9.

## Table 29. Wafer specifications MF1S50yyXDUy

Wafer		
diameter		200 mm typical (8 inches)
maximum diameter after foi	l expansion	210 mm
thickness	MF1S50yyXDUD	120 $\mu$ m $\pm$ 15 $\mu$ m
	MF1S50yyXDUF	$75~\mu m \pm 10~\mu m$
flatness		not applicable
Potential Good Dies per Wa	afer (PGDW)	est. 66264
Wafer backside		
material		Si
treatment		ground and stress relieve
roughness		$R_a max = 0.5 \ \mu m$
		$R_t max = 5 \ \mu m$
Chip dimensions		
step size <sup>[1]</sup>		x = 659 μm
		y = 694 μm
gap between chips <mark>[1]</mark>		typical = 19 μm
		minimum = 5 μm
Passivation		
type		sandwich structure
material		PSG / nitride
thickness		500 nm / 600 nm
Au bump (substrate conn	ected to VSS)	
material		> 99.9 % pure Au
hardness		35 to 80 HV 0.005
shear strength		> 70 MPa
height		18 μm
height uniformity		within a die = $\pm 2 \ \mu m$
		within a wafer = $\pm 3 \ \mu m$
		wafer to wafer = $\pm 4 \ \mu m$
flatness		minimum = $\pm 1.5 \ \mu m$
size		LA, LB, VSS, TEST <sup>[2]</sup> = 66 $\mu$ m × 66 $\mu$ m
size variation		±5 μm
under bump metallization		sputtered TiW

[1] The step size and the gap between chips may vary due to changing foil expansion

[2] Pads VSS and TESTIO are disconnected when wafer is sawn.

## 14.1 Fail die identification

Electronic wafer mapping covers the electrical test results and additionally the results of mechanical/visual inspection. No ink dots are applied.

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Product data sheet
COMPANY PUBLIC
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## 14.2 Package outline

For more details on the contactless modules MOA4 and MOA8 please refer to  $\frac{\text{Ref. 7}}{\text{Ref. 8}}$  and Ref. 8.

PLLMC: plastic leadless module carrier package; 35 mm wide tape

SOT500-2

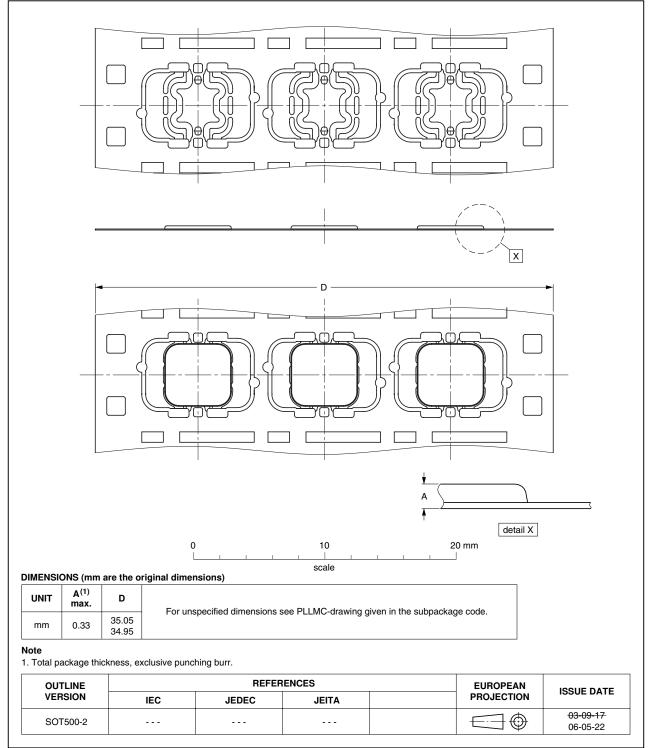
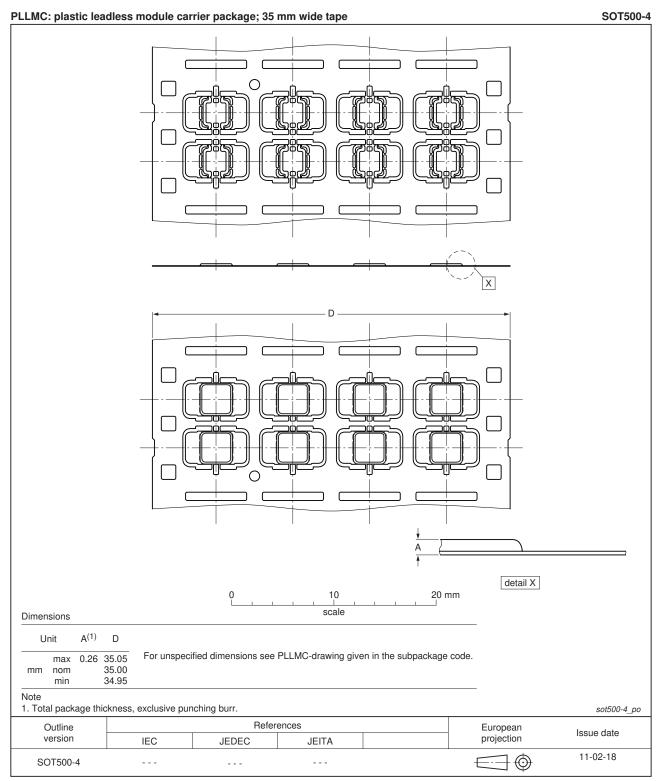


Fig 21. Package outline SOT500-2

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# MF1S50yyX

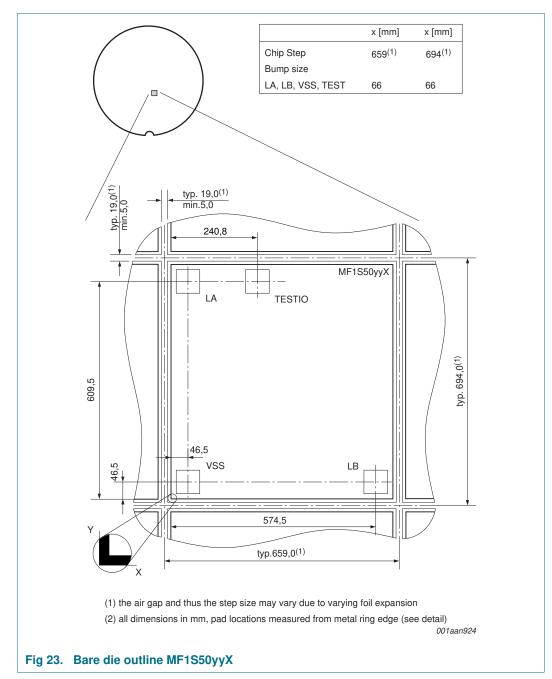
#### MIFARE Classic 1K - Mainstream contactless smart card IC



#### Fig 22. Package outline SOT500-4

# MF1S50yyX

#### MIFARE Classic 1K - Mainstream contactless smart card IC



## 14.3 Bare die outline

MF1S50YYX Product data sheet COMPANY PUBLIC

# **15. Abbreviations**

AcronymDescriptionACKACKnowledgeATQAAnswer To reQuest, Type ACRCCyclic Redundancy CheckCTCascade Tag (value 88h) as defined in ISO/IEC 14443-3 Type AEEPROMElectrically Erasable Programmable Read-Only MemoryFDTFrame Delay TimeFFCFilm Frame CarrierICIntegrated CircuitLCRL = inductance, Capacitance, Resistance (LCR meter)LSBLeast Significant BitNAKNot AcKnowledgeNUIDNon-Unique IDentifierNVNon-Volatile memoryPCDProximity Coupling Device (Contactless Reader)PICCProximity Integrated Circuit Card (Contactless Card)REQAREQuest command, Type ARIDRandom IDRFRadio FrequencyRMSRoot Mean SquareRNGRandom Number GeneratorSAKSelect AcKnowledge, type ASECS-IISEMI Equipment Communications Standard part 2TiWTitanium Tungsten	able 30.	Abbreviations and symbols
ATQAAnswer To reQuest, Type ACRCCyclic Redundancy CheckCTCascade Tag (value 88h) as defined in ISO/IEC 14443-3 Type AEEPROMElectrically Erasable Programmable Read-Only MemoryFDTFrame Delay TimeFFCFilm Frame CarrierICIntegrated CircuitLCRL = inductance, Capacitance, Resistance (LCR meter)LSBLeast Significant BitNAKNot AcKnowledgeNUIDNon-Unique IDentifierNVNon-Volatile memoryPCDProximity Coupling Device (Contactless Reader)PICCProximity Integrated Circuit Card (Contactless Card)REQAREQuest command, Type ARIDRandom IDRFRadio FrequencyRMSRoot Mean SquareRNGRandom Number GeneratorSAKSelect AcKnowledge, type ASECS-IISEMI Equipment Communications Standard part 2	cronym	Description
CRCCyclic Redundancy CheckCTCascade Tag (value 88h) as defined in ISO/IEC 14443-3 Type AEEPROMElectrically Erasable Programmable Read-Only MemoryFDTFrame Delay TimeFFCFilm Frame CarrierICIntegrated CircuitLCRL = inductance, Capacitance, Resistance (LCR meter)LSBLeast Significant BitNAKNot AcKnowledgeNUIDNon-Unique IDentifierNVNon-Volatile memoryPCDProximity Coupling Device (Contactless Reader)PICCProximity Integrated Circuit Card (Contactless Card)REQAREQuest command, Type ARIDRandom IDRFRadio FrequencyRMSRoot Mean SquareRNGRandom Number GeneratorSAKSelect AcKnowledge, type ASECS-IISEMI Equipment Communications Standard part 2	CK	ACKnowledge
CTCascade Tag (value 88h) as defined in ISO/IEC 14443-3 Type AEEPROMElectrically Erasable Programmable Read-Only MemoryFDTFrame Delay TimeFFCFilm Frame CarrierICIntegrated CircuitLCRL = inductance, Capacitance, Resistance (LCR meter)LSBLeast Significant BitNAKNot AcKnowledgeNUIDNon-Unique IDentifierNVNon-Volatile memoryPCDProximity Coupling Device (Contactless Reader)PICCProximity Integrated Circuit Card (Contactless Card)REQAREQuest command, Type ARIDRandom IDRFRadio FrequencyRMSRoot Mean SquareRNGRandom Number GeneratorSAKSelect AcKnowledge, type ASECS-IISEMI Equipment Communications Standard part 2	TQA	Answer To reQuest, Type A
EEPROMElectrically Erasable Programmable Read-Only MemoryFDTFrame Delay TimeFFCFilm Frame CarrierICIntegrated CircuitLCRL = inductance, Capacitance, Resistance (LCR meter)LSBLeast Significant BitNAKNot AcKnowledgeNUIDNon-Unique IDentifierNVNon-Volatile memoryPCDProximity Coupling Device (Contactless Reader)PICCProximity Integrated Circuit Card (Contactless Card)REQAREQuest command, Type ARIDRandom IDRFRadio FrequencyRMSRoot Mean SquareRNGRandom Number GeneratorSAKSelect AcKnowledge, type ASECS-IISEMI Equipment Communications Standard part 2	RC	Cyclic Redundancy Check
FDTFrame Delay TimeFFCFilm Frame CarrierICIntegrated CircuitLCRL = inductance, Capacitance, Resistance (LCR meter)LSBLeast Significant BitNAKNot AcKnowledgeNUIDNon-Unique IDentifierNVNon-Volatile memoryPCDProximity Coupling Device (Contactless Reader)PICCProximity Integrated Circuit Card (Contactless Card)REQAREQuest command, Type ARIDRandom IDRFRadio FrequencyRMSRoot Mean SquareRNGRandom Number GeneratorSAKSelect AcKnowledge, type ASECS-IISEMI Equipment Communications Standard part 2	т	Cascade Tag (value 88h) as defined in ISO/IEC 14443-3 Type A
FFCFilm Frame CarrierICIntegrated CircuitLCRL = inductance, Capacitance, Resistance (LCR meter)LSBLeast Significant BitNAKNot AcKnowledgeNUIDNon-Unique IDentifierNVNon-Volatile memoryPCDProximity Coupling Device (Contactless Reader)PICCProximity Integrated Circuit Card (Contactless Card)REQAREQuest command, Type ARIDRandom IDRFRadio FrequencyRMSRoot Mean SquareRNGRandom Number GeneratorSAKSelect AcKnowledge, type ASECS-IISEMI Equipment Communications Standard part 2	EPROM	Electrically Erasable Programmable Read-Only Memory
ICIntegrated CircuitLCRL = inductance, Capacitance, Resistance (LCR meter)LSBLeast Significant BitNAKNot AcKnowledgeNUIDNon-Unique IDentifierNVNon-Volatile memoryPCDProximity Coupling Device (Contactless Reader)PICCProximity Integrated Circuit Card (Contactless Card)REQAREQuest command, Type ARIDRandom IDRFRadio FrequencyRMSRoot Mean SquareRNGRandom Number GeneratorSAKSelect AcKnowledge, type ASECS-IISEMI Equipment Communications Standard part 2	DT	Frame Delay Time
LCRL = inductance, Capacitance, Resistance (LCR meter)LSBLeast Significant BitNAKNot AcKnowledgeNUIDNon-Unique IDentifierNVNon-Volatile memoryPCDProximity Coupling Device (Contactless Reader)PICCProximity Integrated Circuit Card (Contactless Card)REQAREQuest command, Type ARIDRandom IDRFRadio FrequencyRMSRoot Mean SquareRNGRandom Number GeneratorSAKSelect AcKnowledge, type ASECS-IISEMI Equipment Communications Standard part 2	FC	Film Frame Carrier
LSBLeast Significant BitNAKNot AcKnowledgeNUIDNon-Unique IDentifierNVNon-Volatile memoryPCDProximity Coupling Device (Contactless Reader)PICCProximity Integrated Circuit Card (Contactless Card)REQAREQuest command, Type ARIDRandom IDRFRadio FrequencyRMSRoot Mean SquareRNGRandom Number GeneratorSAKSelect AcKnowledge, type ASECS-IISEMI Equipment Communications Standard part 2	2	Integrated Circuit
NAKNot AcKnowledgeNUIDNon-Unique IDentifierNVNon-Volatile memoryPCDProximity Coupling Device (Contactless Reader)PICCProximity Integrated Circuit Card (Contactless Card)REQAREQuest command, Type ARIDRandom IDRFRadio FrequencyRMSRoot Mean SquareRNGRandom Number GeneratorSAKSelect AcKnowledge, type ASECS-IISEMI Equipment Communications Standard part 2	CR	L = inductance, Capacitance, Resistance (LCR meter)
NUIDNon-Unique IDentifierNVNon-Volatile memoryPCDProximity Coupling Device (Contactless Reader)PICCProximity Integrated Circuit Card (Contactless Card)REQAREQuest command, Type ARIDRandom IDRFRadio FrequencyRMSRoot Mean SquareRNGRandom Number GeneratorSAKSelect AcKnowledge, type ASECS-IISEMI Equipment Communications Standard part 2	SB	Least Significant Bit
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PICCProximity Integrated Circuit Card (Contactless Card)REQAREQuest command, Type ARIDRandom IDRFRadio FrequencyRMSRoot Mean SquareRNGRandom Number GeneratorSAKSelect AcKnowledge, type ASECS-IISEMI Equipment Communications Standard part 2	IV	Non-Volatile memory
REQAREQuest command, Type ARIDRandom IDRFRadio FrequencyRMSRoot Mean SquareRNGRandom Number GeneratorSAKSelect AcKnowledge, type ASECS-IISEMI Equipment Communications Standard part 2	CD	Proximity Coupling Device (Contactless Reader)
RIDRandom IDRFRadio FrequencyRMSRoot Mean SquareRNGRandom Number GeneratorSAKSelect AcKnowledge, type ASECS-IISEMI Equipment Communications Standard part 2	ICC	Proximity Integrated Circuit Card (Contactless Card)
RFRadio FrequencyRMSRoot Mean SquareRNGRandom Number GeneratorSAKSelect AcKnowledge, type ASECS-IISEMI Equipment Communications Standard part 2	IEQA	REQuest command, Type A
RMSRoot Mean SquareRNGRandom Number GeneratorSAKSelect AcKnowledge, type ASECS-IISEMI Equipment Communications Standard part 2	lD	Random ID
RNGRandom Number GeneratorSAKSelect AcKnowledge, type ASECS-IISEMI Equipment Communications Standard part 2	۱F	Radio Frequency
SAKSelect AcKnowledge, type ASECS-IISEMI Equipment Communications Standard part 2	MS	Root Mean Square
SECS-II SEMI Equipment Communications Standard part 2	NG	Random Number Generator
	AK	Select AcKnowledge, type A
TiW Titanium Tungsten	ECS-II	SEMI Equipment Communications Standard part 2
	ïW	Titanium Tungsten
UID Unique IDentifier	IID	Unique IDentifier
WUPA Wake-Up Protocol type A	VUPA	Wake-Up Protocol type A

## 16. References

- [1] MIFARE (Card) Coil Design Guide Application note, BU-ID Document number 0117\*\*1
- [2] MIFARE Type Identification Procedure Application note, BU-ID Document number 0184\*\*1
- [3] ISO/IEC 14443-2 2001
- [4] ISO/IEC 14443-3 2001
- [5] MIFARE & I-CODE CL RC632 Multiple protocol contactless reader IC Product data sheet
- [6] MIFARE and handling of UIDs Application note, BU-ID Document number 1907\*\*1
- [7] Contactless smart card module specification MOA4 Delivery Type Description, BU-ID Document number 0823\*\*1
- [8] Contactless smart card module specification MOA8 Delivery Type Description, BU-ID Document number 1636\*\*1
- [9] General specification for 8" wafer on UV-tape; delivery types Delivery Type Description, BU-ID Document number 1005\*\*1

<sup>1. \*\* ...</sup> document version number

# 17. Revision history

### Table 31.Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
MF1S50YYX v.3.0	20110502	Product data sheet	-	MF1S50YYX v.2.0
Modifications:	<ul> <li>General upo</li> </ul>	date		
MF1S50YYX v.2.0	20101122	Preliminary data sheet	-	-

# **18. Legal information**

## 18.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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